

Table 1

PBSS4112PANP

120 V, 1 A NPN/PNP low VCEsat (BISS) transistor29 November 2012Processor

Product data sheet

nexperia

Product profile 1.

1.1 General description

NPN/PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package. NPN/NPN complement: PBSS4112PAN. PNP/PNP complement: PBSS5112PAP.

1.2 Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM} •
- High collector current gain h_{FF} at high I_{C} •
- Reduced Printed-Circuit Board (PCB) requirements
- High efficiency due to less heat generation
- AEC-Q101 qualified •

1.3 Applications

Ouick reference data

- Load switch •
- Battery-driven devices
- Power management •
- Charging circuits
- Power switches (e.g. motors, fans)

1.4 Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per transist	tor; for the PNP transistor	with negative polarity	<u>I</u>			
V _{CEO}	collector-emitter voltage	open base	-	-	120	V
I _C	collector current		-	-	1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	-	1.5	А
TR1 (NPN)						
R _{CEsat}	collector-emitter saturation resistance	$\begin{split} I_C &= 500 \text{ mA; } I_B = 50 \text{ mA; pulsed;} \\ t_p &\leq 300 \mu\text{s; } \delta \leq 0.02 \text{ ; } T_{amb} = 25 ^\circ\text{C} \end{split}$	-	-	240	mΩ

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
TR2 (PNP)						
R _{CEsat}	collector-emitter saturation resistance	I _C = -500 mA; I _B = -50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02 ; T _{amb} = 25 °C	-	-	440	mΩ

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	6 5 4	C1 B2 E2
2	B1	base TR1		
3	C2	collector TR2	7 8	
4	E2	emitter TR2		
5	B2	base TR2		E1 B1 C2
6	C1	collector TR1	Transparent top view DFN2020-6 (SOT1118)	sym139
7	C1	collector TR1	Britz020-0 (0011110)	
8	C2	collector TR2		

3. Ordering information

Table 3. Ordering in	formation		
Type number	Package		
	Name	Description	Version
PBSS4112PANP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body $2 \times 2 \times 0.65$ mm	SOT1118

4. Marking

Table 4. Marking codes	
Type number	Marking code
PBSS4112PANP	2T

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transisto	r; for the PNP transistor with	negative polarity			_
V _{CBO}	collector-base voltage	open emitter	-	120	V
V _{CEO}	collector-emitter voltage	open base	-	120	V
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Symbol	Parameter	Conditions		Min	Max	Unit
V _{EBO}	emitter-base voltage	open collector		-	7	V
I _C	collector current			-	1	А
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$		-	1.5	А
I _B	base current			-	0.3	А
вм	peak base current	single pulse; $t_p \le 1 \text{ ms}$		-	1	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	370	mW
			[2]	-	570	mW
			[3]	-	530	mW
			[4]	-	700	mW
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			<u>[6]</u>	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

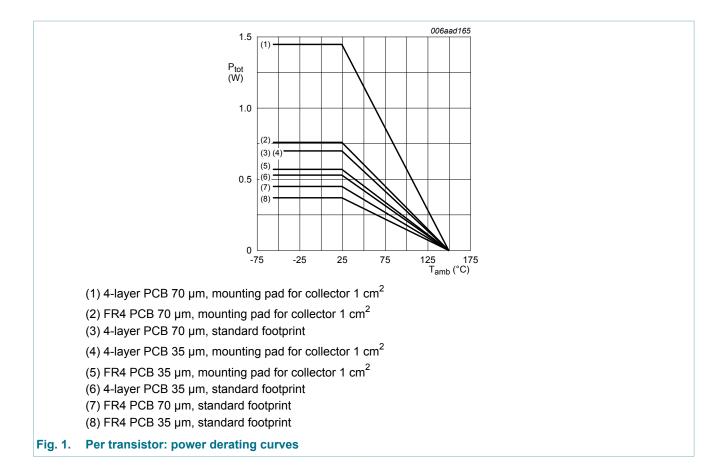
[6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².

[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

^[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

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6. Thermal characteristics

Table 6. T	hermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per transist	tor						
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	338	K/W
	from junction to ambient	1 1 1 1 1 1	[2]	-	-	219	K/W
	ampient		[3]	-	-	236	K/W
			[4]	-	-	179	K/W
			[5]	-	-	278	K/W
			[6]	-	-	164	K/W
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	30	K/W

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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per device							
R _{th(j-a)} thermal resistance from junction to ambient		in free air	[1]	-	-	245	K/W
		[2]	-	-	160	K/W	
		[3]	-	-	171	K/W	
			[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
		[7]	-	-	130	K/W	
			[8]	-	-	63	K/W

Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

^[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

- [6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

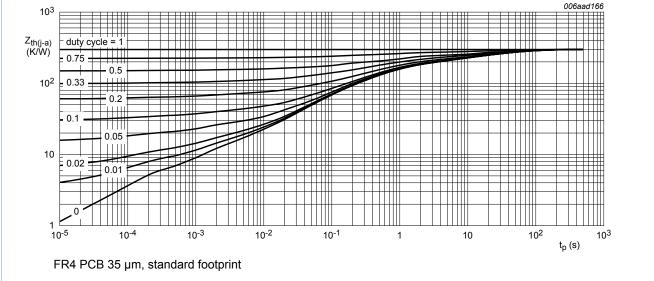
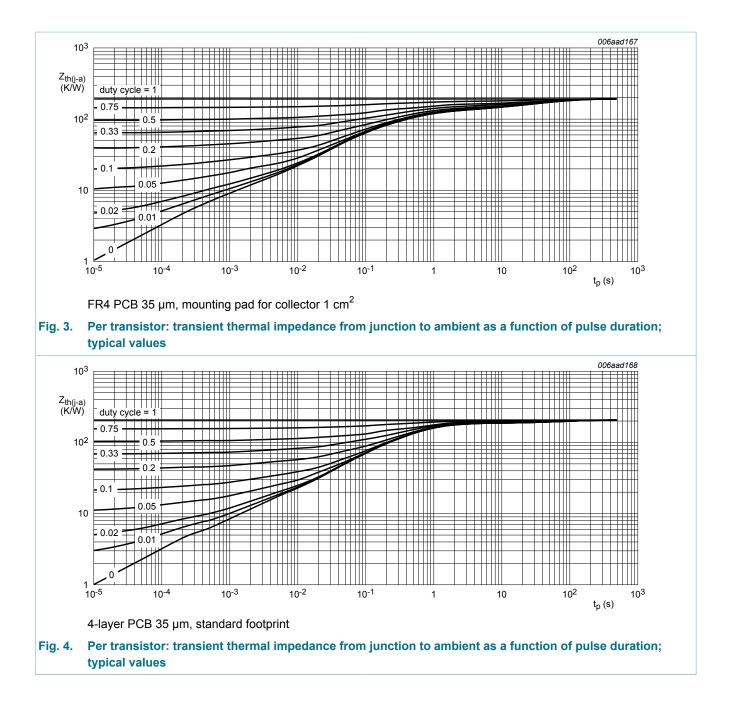


Fig. 2. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

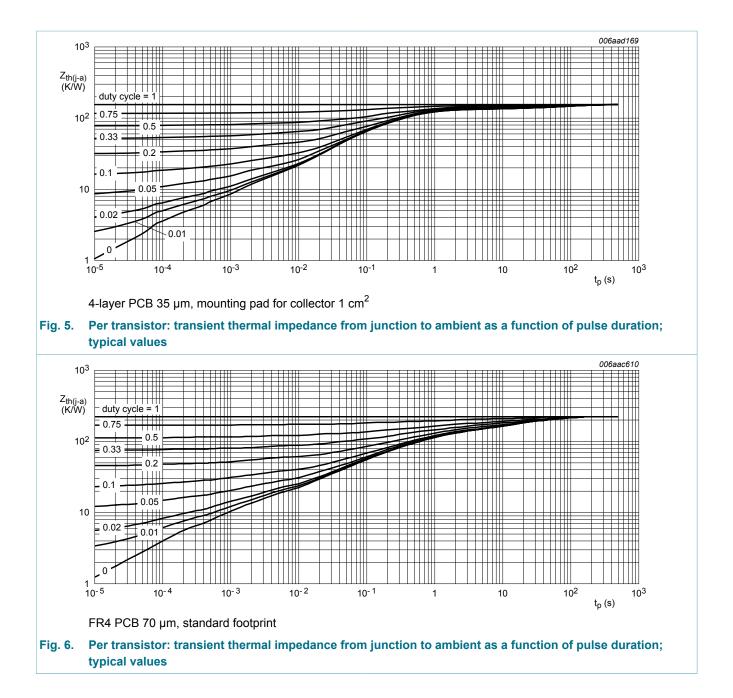


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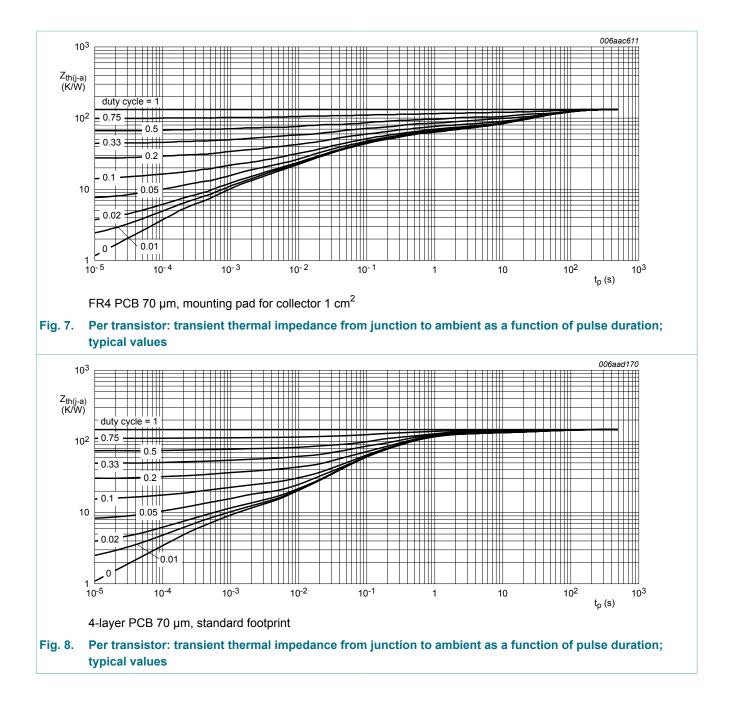


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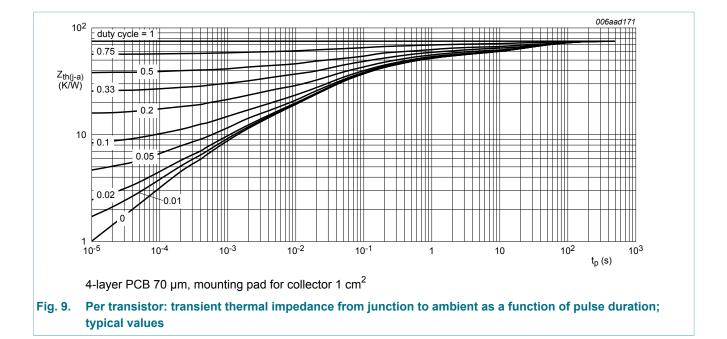
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7. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
TR1 (NPN)			I			
I _{CBO}	collector-base cut-off	V _{CB} = 96 V; I _E = 0 A; T _{amb} = 25 °C	-	-	100	nA
	current	V_{CB} = 96 V; I _E = 0 A; T _j = 150 °C	-	-	50	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V; } I_C = 100 \text{ mA; pulsed;}$ $t_p \le 300 \mu\text{s; } \delta \le 0.02 \text{ ; } T_{amb} = 25 ^\circ\text{C}$	240	375	-	
		$\label{eq:VCE} \begin{array}{l} V_{CE} = 2 \; V; \; I_{C} = 500 \; mA; \; pulsed; \\ t_{p} \leq 300 \; \mu s; \; \delta \leq 0.02 \; ; \; T_{amb} = 25 \; ^{\circ}C \end{array}$	60	100	-	
		$\label{eq:VCE} \begin{array}{l} V_{CE} = 2 \; V; \; I_C = 1 \; A; \; pulsed; \; t_p \leq 300 \; \mu s; \\ \delta \leq 0.02 \; ; \; T_{amb} = 25 \; ^\circ C \end{array}$	30	45	-	
V _{CEsat}	collector-emitter	I _C = 500 mA; I _B = 50 mA; T _{amb} = 25 °C	-	90	120	mV
	saturation voltage	$\begin{split} I_{C} &= 1 \text{ A}; I_{B} = 50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02 ; T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	205	260	mV
		I _C = 1 A; I _B = 100 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02 ; T _{amb} = 25 °C	-	170	220	mV
R _{CEsat}	collector-emitter saturation resistance	I_{C} = 500 mA; I_{B} = 50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; T_{amb} = 25 °C	-	-	240	mΩ

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{BEsat}	base-emitter saturation	I_{C} = 500 mA; I_{B} = 50 mA; T_{amb} = 25 °C	-	-	1	V
	voltage	I_{C} = 1 A; I_{B} = 50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02 ; T_{amb} = 25 °C	-	-	1.1	V
		$\begin{split} I_{C} &= 1 \text{ A}; I_{B} = 100 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02 \text{ ; } \text{T}_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-	1.1	V
V _{BEon}	base-emitter turn-on voltage	$\begin{split} &V_{CE} \texttt{= 2 V; } I_{C} \texttt{= 0.5 A; pulsed;} \\ &t_{p} \texttt{\le 300 \mu s; } \delta \texttt{\le 0.02 ; } T_{amb} \texttt{= 25 °C} \end{split}$	-	-	0.9	V
t _d	delay time	V_{CC} = 10 V; I _C = 500 mA; I _{Bon} = 25 mA;	-	20	-	ns
t _r	rise time	I _{Boff} = -25 mA; T _{amb} = 25 °C	-	440	-	ns
t _{on}	turn-on time	-	-	460	-	ns
t _s	storage time	_	-	615	-	ns
t _f	fall time		-	390	-	ns
t _{off}	turn-off time		-	1005	-	ns
f _T	transition frequency	$V_{CE} = 10 \text{ V}; \text{ I}_{C} = 50 \text{ mA}; \text{ f} = 100 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	60	120	-	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	4.5	7	pF
TR2 (PNP)						
020	collector-base cut-off	V _{CB} = -96 V; I _E = 0 A	-	-	-100	nA
	current	V_{CB} = -96 V; I _E = 0 A; T _j = 150 °C	-	-	-50	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = -5 V; I _C = 0 A	-	-	-100	nA
h _{FE}	DC current gain	$\begin{split} V_{CE} &= -2 \text{ V}; \text{ I}_{C} = -100 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02 ; \text{T}_{amb} = 25 ^{\circ}\text{C} \end{split}$	190	305	-	
		$ \begin{aligned} &V_{CE} \texttt{=} \texttt{-2} \; V \texttt{;} \; I_{C} \texttt{=} \texttt{-500 mA}\texttt{;} \; \texttt{pulsed}\texttt{;} \\ &t_{p} \texttt{\leq} \texttt{300} \; \texttt{\mu}\texttt{s}\texttt{;} \; \overline{\delta} \texttt{\leq} \texttt{0.02} \texttt{;} \; T_{amb} \texttt{=} \texttt{25} \; ^{\circ}C \end{aligned} $	50	85	-	
		$\begin{split} V_{CE} &= -2 \text{ V}; \text{ I}_{C} = -1 \text{ A}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \overline{\delta} &\leq 0.02 ; T_{amb} = 25 ^{\circ}\text{C} \end{split}$	15	25	-	
V _{CEsat}	collector-emitter saturation voltage	$\begin{split} I_{C} &= -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \overline{\delta} &\leq 0.02 ; T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-150	-220	mV
		I_C = -1 A; I_B = -100 mA; pulsed; $t_p \le 300$ μs; δ ≤ 0.02 ; T_{amb} = 25 °C	-	-335	-480	mV
R _{CEsat}	collector-emitter saturation resistance	I _C = -500 mA; I _B = -50 mA; pulsed; t _p ≤ 300 μs; $\overline{\delta}$ ≤ 0.02 ; T _{amb} = 25 °C	-	-	440	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = -500 mA; I _B = -50 mA; T _{amb} = 25 °C	-	-	-1	V
		I_{C} = -1 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; $\overline{\delta} \le 0.02$; T_{amb} = 25 °C	-	-	-1.1	V

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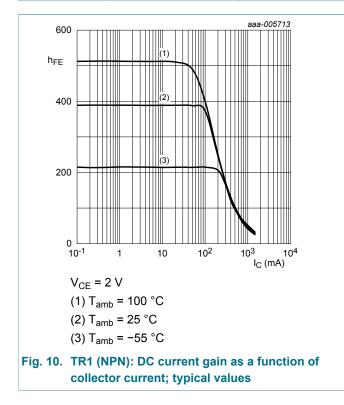
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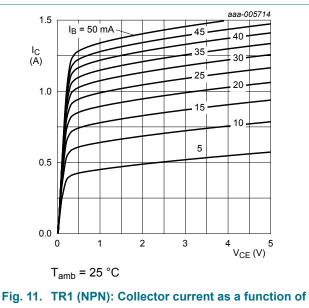
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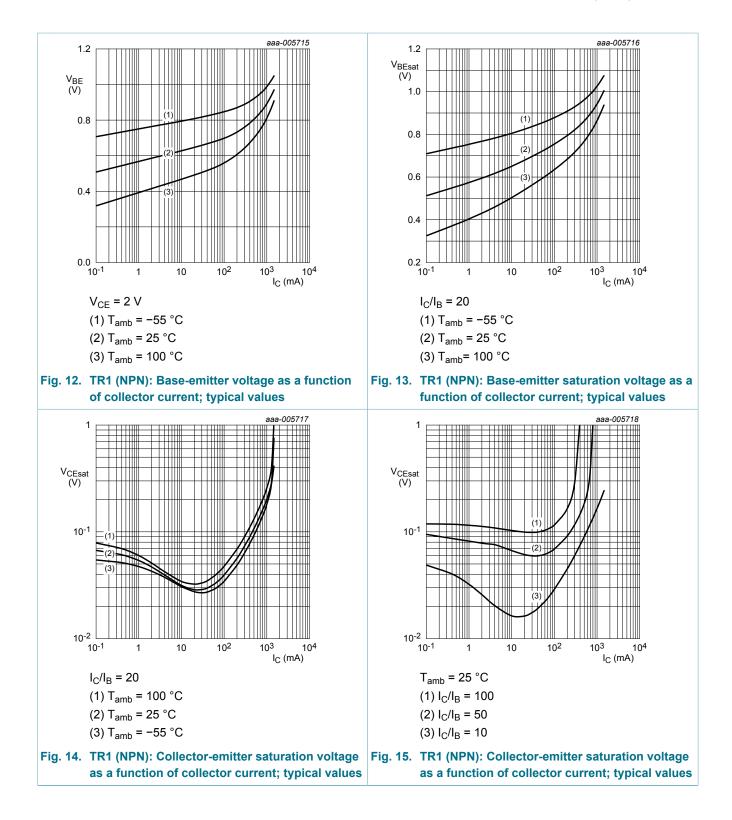
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{BEon}	base-emitter turn-on voltage	$\label{eq:VcE} \begin{array}{l} V_{CE} \texttt{=} \texttt{-2 V}; \ I_{C} \texttt{=} \texttt{-0.5 A}; \ \texttt{pulsed}; \\ t_{p} \texttt{\leq} \texttt{300 } \texttt{\mu}\texttt{s}; \ \texttt{\delta} \texttt{\leq} \texttt{0.02} ; \ T_{amb} \texttt{=} \texttt{25 °C} \end{array}$		-	-	-0.9	V
t _d	delay time	$V_{CC} = -10 \text{ V}; \text{ I}_{C} = -500 \text{ mA};$ $\text{I}_{Bon} = -25 \text{ mA}; \text{ I}_{Boff} = 25 \text{ mA};$ $\text{T}_{amb} = 25 \text{ °C}$		-	15	-	ns
t _r	rise time			-	245	-	ns
t _{on}	turn-on time			-	260	-	ns
ts	storage time			-	290	-	ns
t _f	fall time			-	270	-	ns
t _{off}	turn-off time			-	560	-	ns
f _T	transition frequency	V_{CE} = -10 V; I _C = -50 mA; f = 100 MHz; T _{amb} = 25 °C		50	100	-	MHz
C _c	collector capacitance	V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C		-	9.5	13	pF







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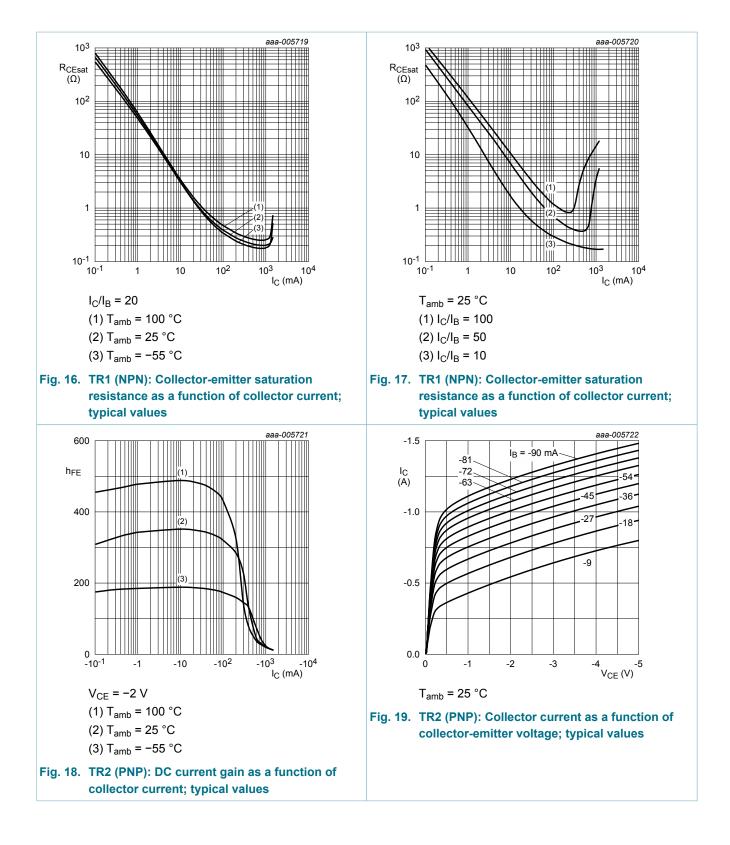


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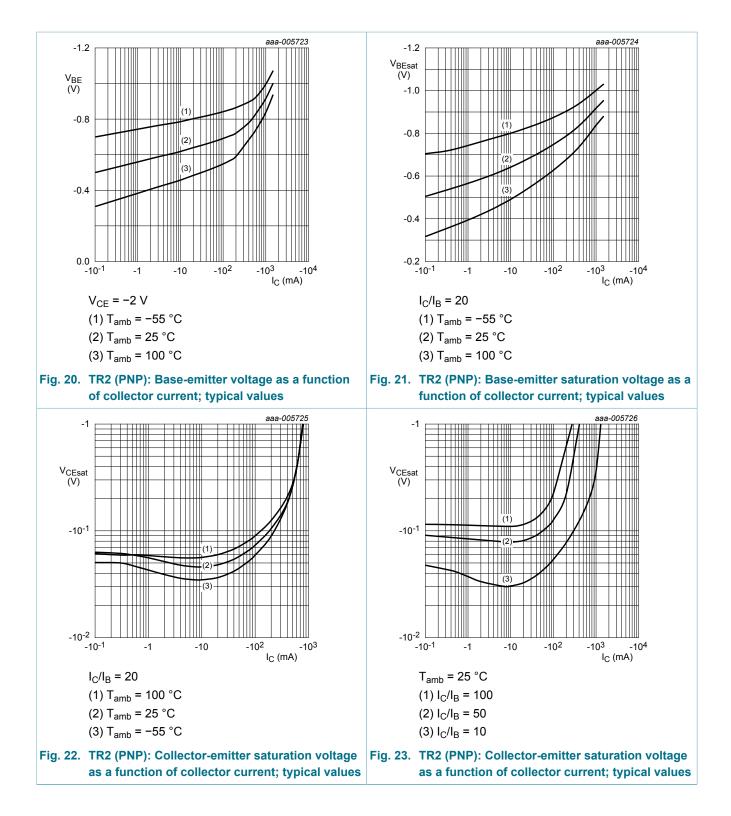
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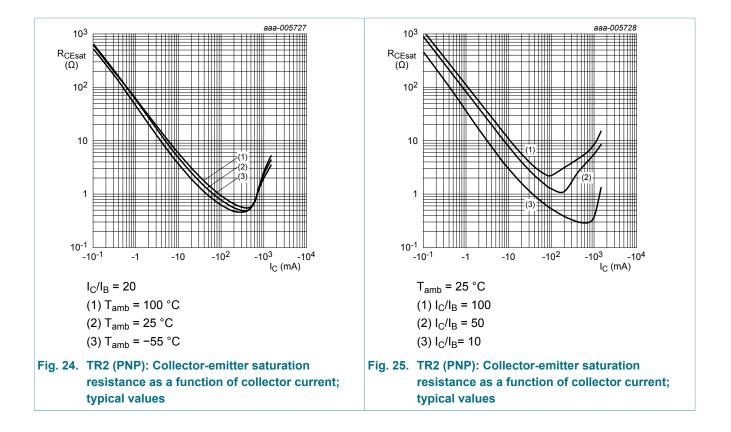


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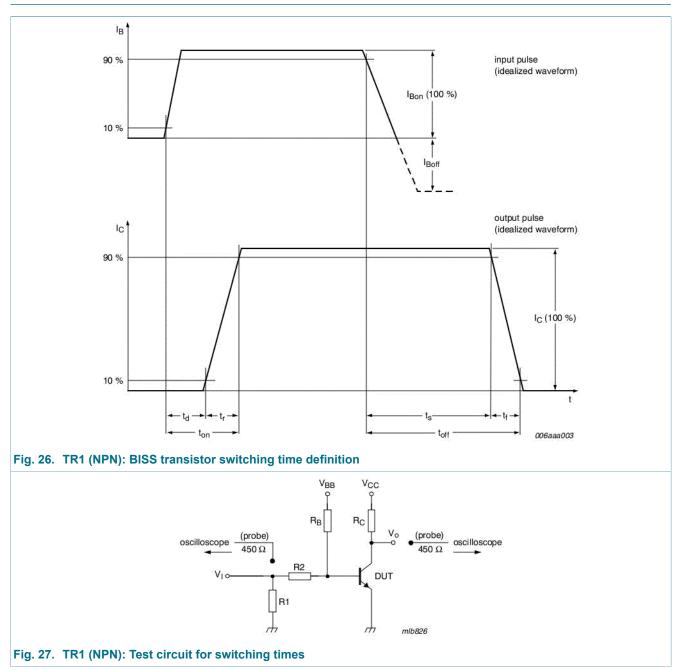


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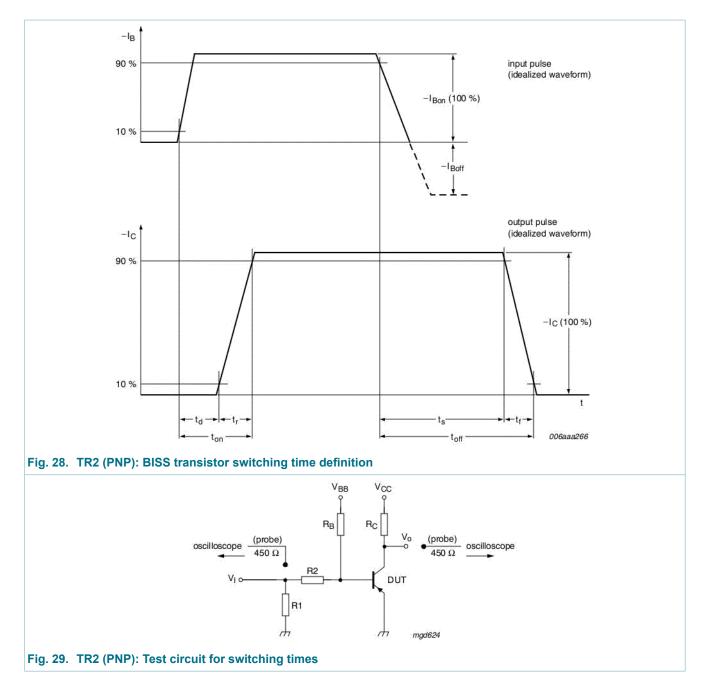
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8. Test information

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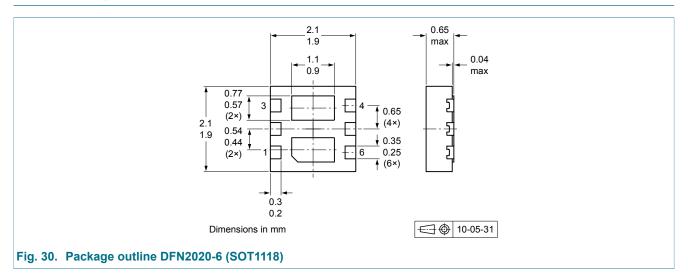
8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

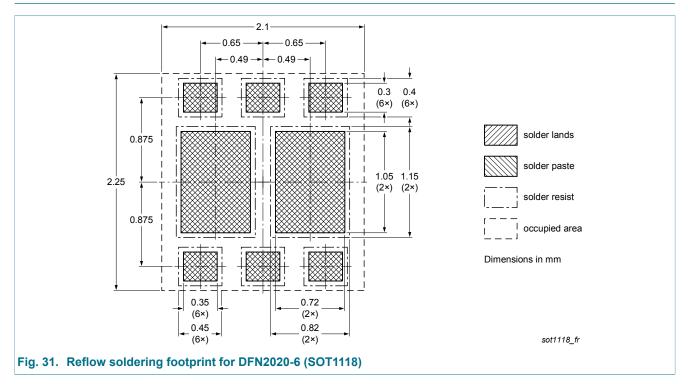
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9. Package outline



10. Soldering



11. Revision history

Table 8. Revision his	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4112PANP v.1	20121129	Product data sheet	-	-
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Product data sheet		29 November 2012		18 / 21

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12. Legal information

12.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

29 November 2012

120 V, 1 A NPN/PNP low VCEsat (BISS) transistor

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